

Microsemi Scottsdale

Version 02-16-15

Material Declaration						
<u>Parts Number</u>	<u>Package</u>	<u>Package Total Mass in grams (g).</u>				
	DO-7 (e3)	0.2348				
<u>Component Description</u>	<u>Material Name</u>	<u>Weight in grams</u>	<u>Substance Name</u>	<u>CAS Number</u>	<u>Weight in grams</u>	<u>Percent</u>
Glass Sleeve	Glass	0.0421	Lead	7439-92-1	0.012209	29%
			Silica	7631-86-9	0.029891	71%
Die Attachment	Preforms	0.00162	Lead	7439-92-1	0.001539	95%
			Tin	7440-31-5	0.000081	5%
Leads	Dumet	0.1846	Copper	7440-50-8	0.044304	24%
			Nickel	7440-02-0	0.07384	40%
			Iron	8053-60-9	0.066456	36%
Die	Silicon	0.000385331	Silicon	7440-21-3	0.000385331	100%
			Chrome	7440-47-3	5.77997E-11	0%
			Silver	7440-22-4	1.54132E-10	0%
			Gold	7440-57-5	1.81106E-10	0%
Plating-under coat	Nickel	0.001	Nickel	7440-02-0	0.001	100%
Plating- final Finsh	Tin/Lead	0.0051	Tin	7440-31-5	0.0051	100%
			Total		0.234805331	